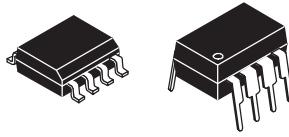




# THE DATASHEET OF SN75HVD06DR





## HIGH OUTPUT RS-485 TRANSCEIVERS

 Check for Samples: [SN65HVD05](#), [SN65HVD06](#), [SN75HVD05](#), [SN65HVD07](#), [SN75HVD06](#), [SN75HVD07](#)

### FEATURES

- Minimum Differential Output Voltage of 2.5 V Into a 54-Ω Load
- Open-Circuit, Short-Circuit, and Idle-Bus Failsafe Receiver
- 1/8<sup>th</sup> Unit-Load Option Available (Up to 256 Nodes on the Bus)
- Bus-Pin ESD Protection Exceeds 16 kV HBM
- Driver Output Slew Rate Control Options
- Electrically Compatible With ANSI TIA/EIA-485-A Standard
- Low-Current Standby Mode: 1 μA Typical
- Glitch-Free Power-Up and Power-Down Protection for Hot-Plugging Applications
- Pin Compatible With Industry Standard SN75176

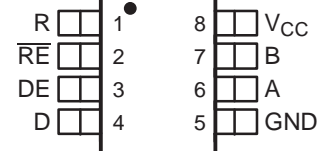
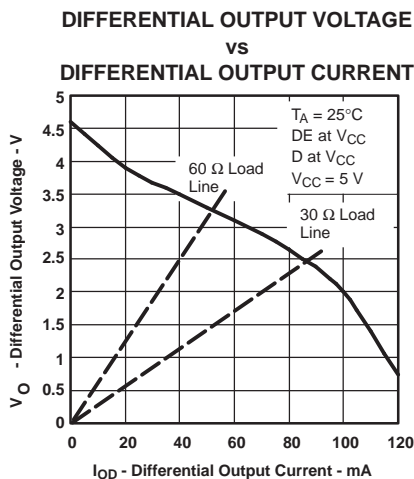
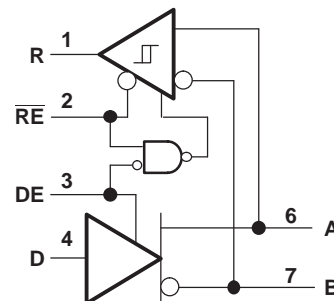
### APPLICATIONS

- Data Transmission Over Long or Lossy Lines or Electrically Noisy Environments
- Profibus Line Interface
- Industrial Process Control Networks
- Point-of-Sale (POS) Networks
- Electric Utility Metering
- Building Automation
- Digital Motor Control

### DESCRIPTION

The SN65HVD05, SN75HVD05, SN65HVD06, SN75HVD06, SN65HVD07, and SN75HVD07 combine a 3-state differential line driver and differential line receiver. They are designed for balanced data transmission and interoperate with ANSI TIA/EIA-485-A and ISO 8482E standard-compliant devices. The driver is designed to provide a differential output voltage greater than that required by these standards for increased noise margin. The drivers and receivers have active-high and active-low enables respectively, which can be externally connected together to function as direction control.

The driver differential outputs and receiver differential inputs connect internally to form a differential input/output (I/O) bus port that is designed to offer minimum loading to the bus whenever the driver is disabled or not powered. These devices feature wide positive and negative common-mode voltage ranges, making them suitable for party-line applications.

**D OR P PACKAGE  
(TOP VIEW)**

**LOGIC DIAGRAM  
(POSITIVE LOGIC)**


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### ORDERING INFORMATION<sup>(1)</sup>

SIGNALING RATE	UNIT LOAD	DRIVER OUTPUT SLOPE CONTROL	T <sub>A</sub>	PART NUMBER <sup>(2)</sup>		MARKED AS	
						PLASTIC DUAL-IN-LINE PACKAGE (PDIP)	SMALL OUTLINE IC (SOIC) PACKAGE
40 Mbps	1/2	No	–40°C to 85°C	SN65HVD05D	SN65HVD05P	65HVD05	VP05
10 Mbps	1/8	Yes		SN65HVD06D	SN65HVD06P	65HVD06	VP06
1 Mbps	1/8	Yes		SN65HVD07D	SN65HVD07P	65HVD07	VP07
40 Mbps	1/2	No	0°C to 70°C	SN75HVD05D	SN75HVD05P	75HVD05	VN05
10 Mbps	1/8	Yes		SN75HVD06D	SN75HVD06P	75HVD06	VN06
1 Mbps	1/8	Yes		SN75HVD07D	SN75HVD07P	75HVD07	VN07

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

(2) The D package is available taped and reeled. Add an R suffix to the device type (i.e., SN65HVD05DR).

### PACKAGE DISSIPATION RATINGS

(See [Figure 12](#) and [Figure 13](#))

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	DERATING FACTOR <sup>(1)</sup> ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING
D <sup>(2)</sup>	710 mW	5.7 mW/°C	455 mW	369 mW
D <sup>(3)</sup>	1282 mW	10.3 mW/°C	821 mW	667 mW
P	1000 mW	8.0 mW/°C	640 mW	520 mW

(1) This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

(2) Tested in accordance with the Low-K thermal metric definitions of EIA/JESD51-3

(3) Tested in accordance with the High-K thermal metric definitions of EIA/JESD51-7

### ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted<sup>(1) (2)</sup>

			<b>SN65HVD05, SN65HVD06, SN65HVD07 SN75HVD05, SN75HVD06, SN75HVD07</b>
Supply voltage range, V <sub>CC</sub>			–0.3 V to 6 V
Voltage range at A or B			–9 V to 14 V
Input voltage range at D, DE, R or $\overline{RE}$			–0.5 V to V <sub>CC</sub> + 0.5 V
Voltage input range, transient pulse, A and B, through 100 Ω (see <a href="#">Figure 11</a> )			–50 V to 50 V
Receiver output current, I <sub>O</sub>			–11 mA to 11mA
Electrostatic discharge	Human body model <sup>(3)</sup>	A, B, and GND	16 kV
		All pins	4 kV
	Charged-device model <sup>(4)</sup>	All pins	1 kV
Continuous total power dissipation			See Dissipation Rating Table

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.

(3) Tested in accordance with JEDEC Standard 22, Test Method A114-A.

(4) Tested in accordance with JEDEC Standard 22, Test Method C101.

## RECOMMENDED OPERATING CONDITIONS

		MIN	NOM	MAX	UNIT
Supply voltage, $V_{CC}$		4.5		5.5	V
Voltage at any bus terminal (separately or common mode) $V_I$ or $V_{IC}$		-7 <sup>(1)</sup>		12	V
High-level input voltage, $V_{IH}$	D, DE, $\overline{RE}$	2			V
Low-level input voltage, $V_{IL}$	D, DE, $\overline{RE}$			0.8	V
Differential input voltage, $V_{ID}$ (see <a href="#">Figure 7</a> )		-12		12	V
High-level output current, $I_{OH}$	Driver	-100			mA
	Receiver	-8			
Low-level output current, $I_{OL}$	Driver			100	mA
	Receiver			8	
Operating free-air temperature, $T_A$	SN65HVD05	-40		85	°C
	SN65HVD06				
	SN65HVD07				
	SN75HVD05	0		70	°C
	SN75HVD06				
	SN75HVD07				

(1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum is used in this data sheet.

## DRIVER ELECTRICAL CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>(1)</sup>	MAX	UNIT
$V_{IK}$	Input clamp voltage	$I_I = -18$ mA		-1.5			V
$ V_{OD} $	Differential output voltage	No Load				$V_{CC}$	V
		$R_L = 54 \Omega$ , See <a href="#">Figure 4</a>		2.5			
		$V_{test} = -7$ V to 12 V, See <a href="#">Figure 2</a>		2.2			
$\Delta V_{OD} $	Change in magnitude of differential output voltage	See <a href="#">Figure 4</a> and <a href="#">Figure 2</a>		-0.2		0.2	V
$V_{OC(SS)}$	Steady-state common-mode output voltage	See <a href="#">Figure 3</a>		2.2		3.3	V
$\Delta V_{OC(SS)}$	Change in steady-state common-mode output voltage	See <a href="#">Figure 3</a>		-0.1		0.1	V
$V_{OC(PP)}$	Peak-to-peak common-mode output voltage	HVD05	See <a href="#">Figure 3</a>			600	mV
		HVD06		500			
		HVD07		900			
$I_{OZ}$	High-impedance output current	See receiver input currents					
$I_I$	Input current	D		-100		0	$\mu$ A
		DE		0		100	
$I_{OS}$	Short-circuit output current	$-7$ V $\leq V_O \leq 12$ V		-250		250	mA
$C_{(diff)}$	Differential output capacitance	$V_{ID} = 0.4 \sin(4E6\pi t) + 0.5$ V, DE at 0 V			16		pF
$I_{CC}$	Supply current	$\overline{RE}$ at $V_{CC}$ , D and DE at $V_{CC}$ , No load	Receiver disabled and driver enabled		9	15	mA
		$\overline{RE}$ at $V_{CC}$ , D at $V_{CC}$ DE at 0 V, No load	Receiver disabled and driver disabled (standby)		1	5	$\mu$ A
		$\overline{RE}$ at 0 V, D and DE at $V_{CC}$ , No load	Receiver enabled and driver enabled		9	15	mA

(1) All typical values are at 25°C and with a 5-V supply.

## DRIVER SWITCHING CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

PARAMETER		TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low-to-high-level output	HVD05		6.5	11	ns
		HVD06		27	40	
		HVD07		250	400	
t <sub>PHL</sub>	Propagation delay time, high-to-low-level output	HVD05		6.5	11	ns
		HVD06		27	40	
		HVD07		250	400	
t <sub>r</sub>	Differential output signal rise time	HVD05		2.7	3.6	ns
		HVD06		18	28	
		HVD07		150	300	
t <sub>f</sub>	Differential output signal fall time	HVD05	R <sub>L</sub> = 54 Ω, C <sub>L</sub> = 50 pF, See Figure 4	2.7	3.6	ns
		HVD06		18	28	
		HVD07		150	300	
t <sub>sk(p)</sub>	Pulse skew ( t <sub>PHL</sub> - t <sub>PLH</sub>  )	HVD05			2	ns
		HVD06			2.5	
		HVD07			10	
t <sub>sk(pp)</sub> <sup>(2)</sup>	Part-to-part skew	HVD05			3.5	ns
		HVD06			14	
		HVD07			100	
t <sub>PZH1</sub>	Propagation delay time, high-impedance-to-high-level output	HVD05			25	ns
		HVD06			45	
		HVD07			250	
t <sub>PHZ</sub>	Propagation delay time, high-level-to-high-impedance output	HVD05	R <sub>Ē</sub> at 0 V, R <sub>L</sub> = 110 Ω, See Figure 5		25	ns
		HVD06			60	
		HVD07			250	
t <sub>PZL1</sub>	Propagation delay time, high-impedance-to-low-level output	HVD05			15	ns
		HVD06			45	
		HVD07			200	
t <sub>PLZ</sub>	Propagation delay time, low-level-to-high-impedance output	HVD05	R <sub>Ē</sub> at 0 V, R <sub>L</sub> = 110 Ω, See Figure 6		14	ns
		HVD06			90	
		HVD07			550	
t <sub>PZH2</sub>	Propagation delay time, standby-to-high-level output		R <sub>L</sub> = 110 Ω, R <sub>Ē</sub> at 3 V, See Figure 5		6	μs
t <sub>PZL2</sub>	Propagation delay time, standby-to-low-level output		R <sub>L</sub> = 110 Ω, R <sub>Ē</sub> at 3 V, See Figure 6		6	μs

(1) All typical values are at 25°C and with a 5-V supply.

(2) t<sub>sk(pp)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## RECEIVER ELECTRICAL CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>(1)</sup>	MAX	UNIT	
$V_{IT+}$	Positive-going input threshold voltage	$I_O = -8 \text{ mA}$				-0.01	V	
$V_{IT-}$	Negative-going input threshold voltage	$I_O = 8 \text{ mA}$		-0.2				
$V_{hys}$	Hysteresis voltage ( $V_{IT+} - V_{IT-}$ )				35		mV	
$V_{IK}$	Enable-input clamp voltage	$I_I = -18 \text{ mA}$		-1.5			V	
$V_{OH}$	High-level output voltage	$V_{ID} = 200 \text{ mV}$ ,	$I_{OH} = -8 \text{ mA}$ ,	See <a href="#">Figure 7</a>		4	V	
$V_{OL}$	Low-level output voltage	$V_{ID} = -200 \text{ mV}$ ,	$I_{OL} = 8 \text{ mA}$ ,	See <a href="#">Figure 7</a>		0.4	V	
$I_{OZ}$	High-impedance-state output current	$V_O = 0 \text{ or } V_{CC}$	$\overline{RE}$ at $V_{CC}$	-1		1	$\mu\text{A}$	
$I_I$	Bus input current	HVD05	Other input at 0 V	$V_A \text{ or } V_B = 12 \text{ V}$		0.23	0.5	mA
				$V_A \text{ or } V_B = 12 \text{ V}, V_{CC} = 0 \text{ V}$		0.3	0.5	
				$V_A \text{ or } V_B = -7 \text{ V}$		-0.4	0.13	
				$V_A \text{ or } V_B = -7 \text{ V}, V_{CC} = 0 \text{ V}$		-0.4	0.15	
		HVD06 HVD07	Other input at 0 V	$V_A \text{ or } V_B = 12 \text{ V}$		0.06	0.1	mA
				$V_A \text{ or } V_B = 12 \text{ V}, V_{CC} = 0 \text{ V}$		0.08	0.13	
				$V_A \text{ or } V_B = -7 \text{ V}$		-0.1	0.05	
				$V_A \text{ or } V_B = -7 \text{ V}, V_{CC} = 0 \text{ V}$		-0.05	0.03	
$I_{IH}$	High-level input current, $\overline{RE}$	$V_{IH} = 2 \text{ V}$		-60	26.4		$\mu\text{A}$	
$I_{IL}$	Low-level input current, $\overline{RE}$	$V_{IL} = 0.8 \text{ V}$		-60	27.4		$\mu\text{A}$	
$C_{(diff)}$	Differential input capacitance	$V_I = 0.4 \sin(4E6\pi t) + 0.5 \text{ V}$ , DE at 0 V			16		pF	
$I_{CC}$	Supply current	$\overline{RE}$ at 0 V, D and DE at 0 V, No load	Receiver enabled and driver disabled	5	10		mA	
		$\overline{RE}$ at $V_{CC}$ , DE at 0 V, D at $V_{CC}$ , No load	Receiver disabled and driver disabled (standby)	1	5		$\mu\text{A}$	
		$\overline{RE}$ at 0 V, D and DE at $V_{CC}$ , No load	Receiver enabled and driver enabled	9	15		mA	

(1) All typical values are at 25°C and with a 5-V supply.

## RECEIVER SWITCHING CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

PARAMETER		TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT	
$t_{PLH}$	Propagation delay time, low-to-high-level output 1/2 UL	HVD05		14.6	25	ns	
$t_{PHL}$	Propagation delay time, high-to-low-level output 1/2 UL	HVD05		14.6	25	ns	
$t_{PLH}$	Propagation delay time, low-to-high-level output 1/8 UL	HVD06		55	70	ns	
		HVD07		55	70		
$t_{PHL}$	Propagation delay time, high-to-low-level output 1/8 UL	HVD06	$V_{ID} = -1.5\text{ V to }1.5\text{ V},$ $C_L = 15\text{ pF},$ See Figure 8	55	70	ns	
		HVD07		55	70		
$t_{sk(p)}$	Pulse skew ( $t_{PHL} - t_{PLH}$ )	HVD05				2	ns
		HVD06				4.5	
		HVD07			4.5		
$t_{sk(pp)}$ <sup>(2)</sup>	Part-to-part skew	HVD05			6.5	ns	
		HVD06			14		
		HVD07			14		
$t_r$	Output signal rise time	$C_L = 15\text{ pF},$ See Figure 8		2	3	ns	
$t_f$	Output signal fall time			2	3		
$t_{PZH1}$	Output enable time to high level	$C_L = 15\text{ pF},$ DE at 3 V, See Figure 9			10	ns	
$t_{PZL1}$	Output enable time to low level				10		
$t_{PHZ}$	Output disable time from high level				15		
$t_{PLZ}$	Output disable time from low level				15		
$t_{PZH2}$	Propagation delay time, standby-to-high-level output	$C_L = 15\text{ pF},$ DE at 0, See Figure 10			6	$\mu\text{s}$	
$t_{PZL2}$	Propagation delay time, standby-to-low-level output				6		

- (1) All typical values are at 25°C and with a 5-V supply.  
 (2)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## PARAMETER MEASUREMENT INFORMATION

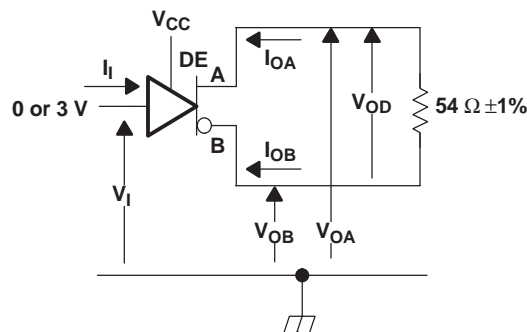


Figure 1. Driver  $V_{OD}$  Test Circuit and Voltage and Current Definitions

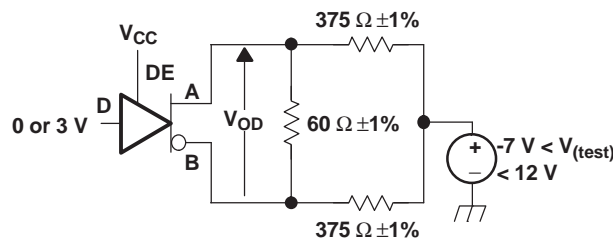
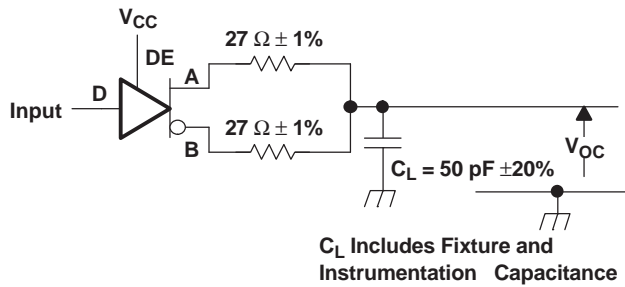
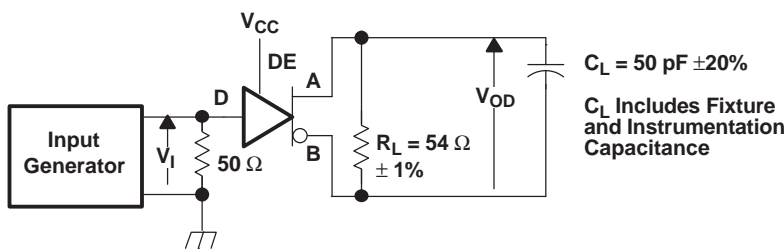
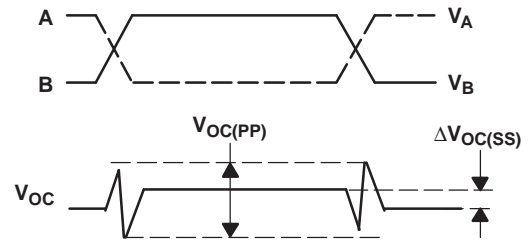


Figure 2. Driver  $V_{OD}$  With Common-Mode Loading Test Circuit



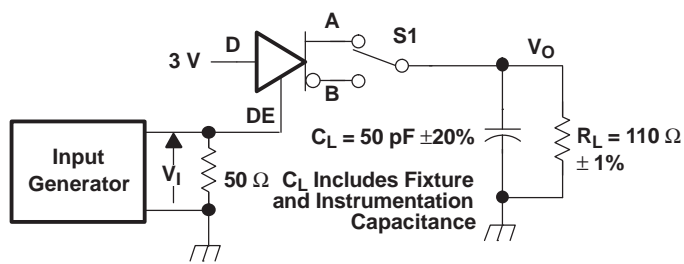
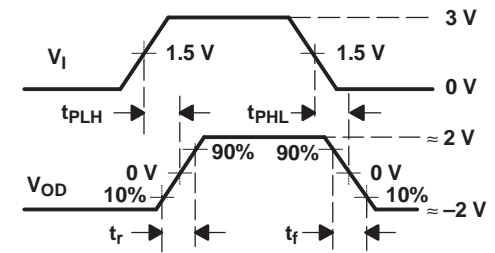
Input: PRR = 500 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

Figure 3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage



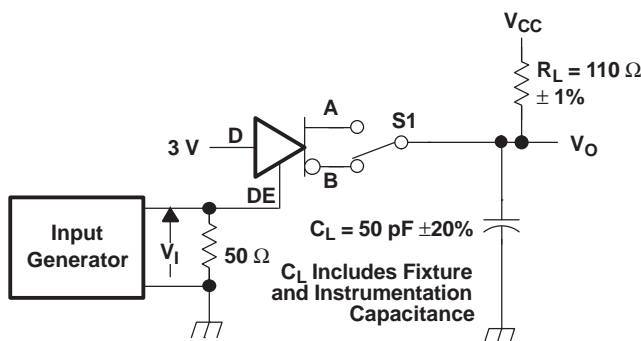
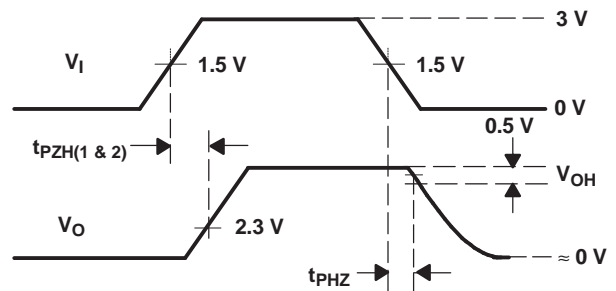
Generator: PRR = 500 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

Figure 4. Driver Switching Test Circuit and Voltage Waveforms



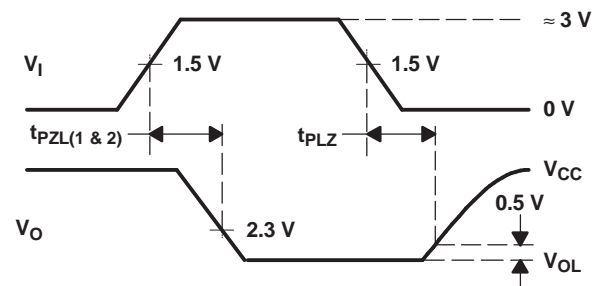
Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

Figure 5. Driver High-Level Enable and Disable Time Test Circuit and Voltage Waveforms



Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

Figure 6. Driver Low-Level Output Enable and Disable Time Test Circuit and Voltage Waveforms



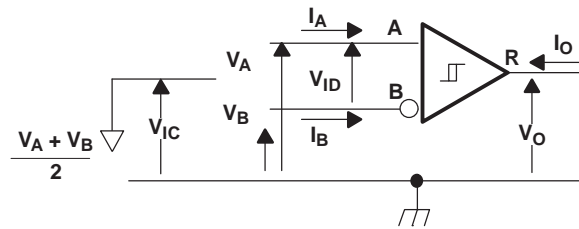


Figure 7. Receiver Voltage and Current Definitions

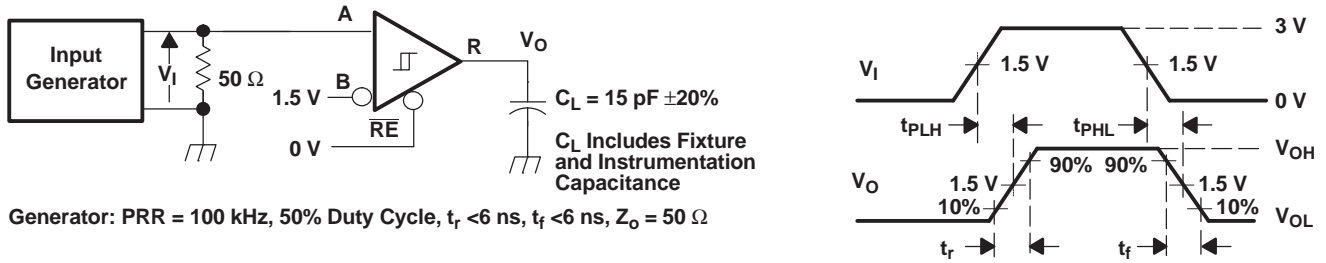


Figure 8. Receiver Switching Test Circuit and Voltage Waveforms

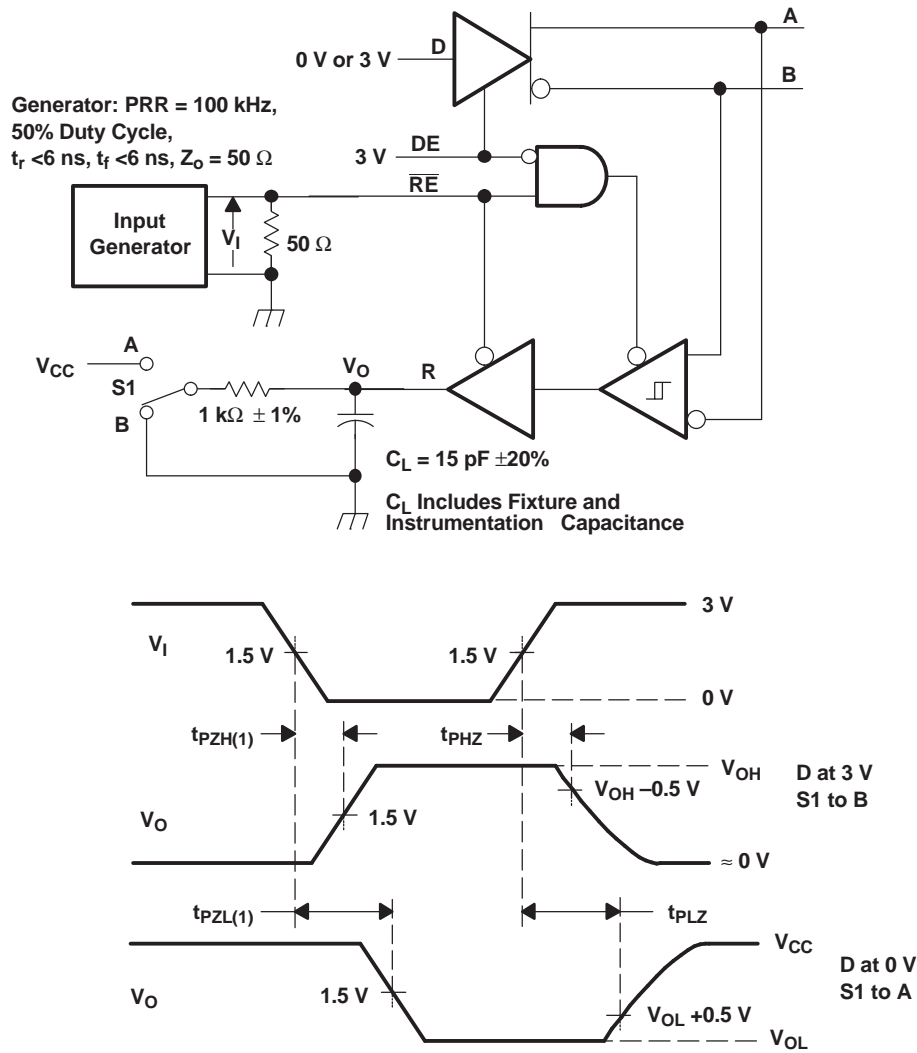


Figure 9. Receiver Enable and Disable Time Test Circuit and Voltage Waveforms With Drivers Enabled

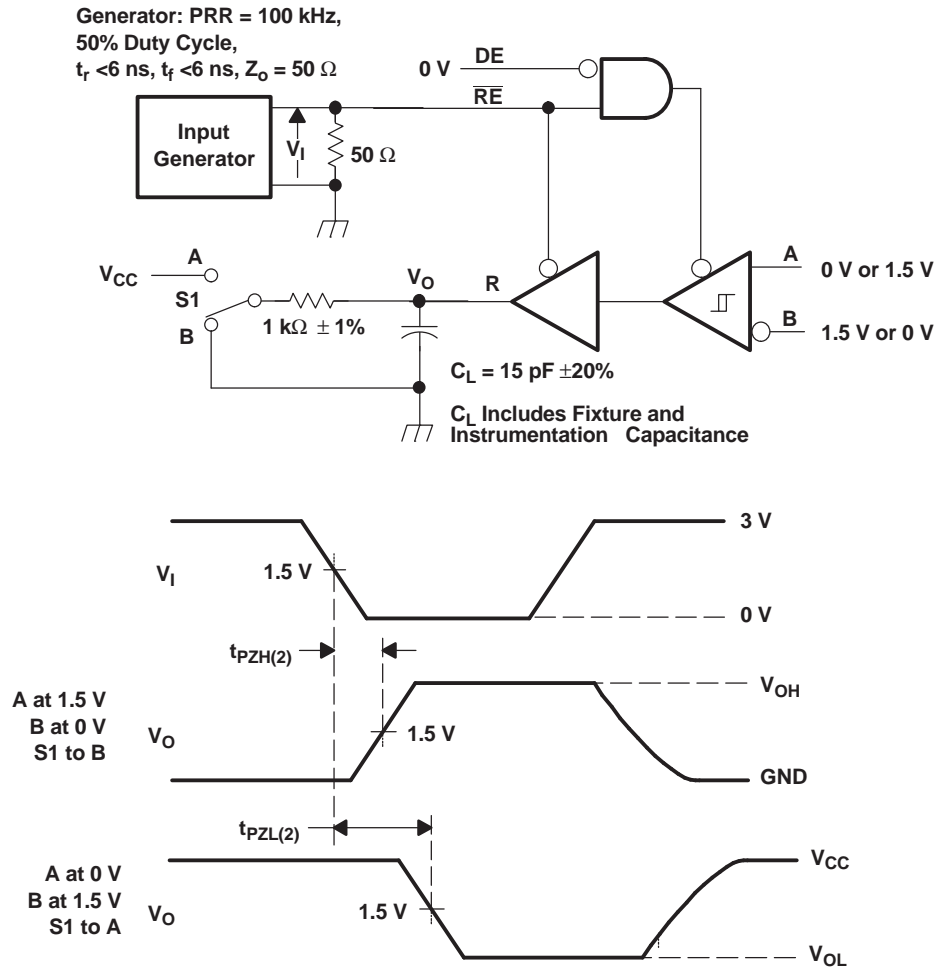
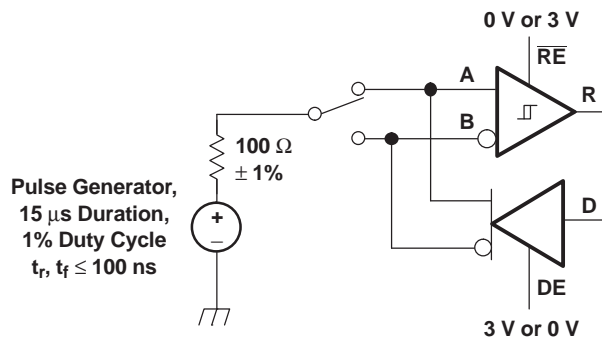


Figure 10. Receiver Enable Time From Standby (Driver Disabled)



NOTE: This test is conducted to test survivability only. Data stability at the R output is not specified.

Figure 11. Test Circuit, Transient Over Voltage Test

## FUNCTION TABLES

**Table 1. DRIVER**

INPUT D	ENABLE	OUTPUTS	
	DE	A	B
H	H	H	L
L	H	L	H
X	L	Z	Z
Open	H	H	L
X	Open	Z	Z

**Table 2. RECEIVER<sup>(1)</sup>**

DIFFERENTIAL INPUTS $V_{ID} = V_A - V_B$	ENABLE $\overline{RE}$	OUTPUT R
$V_{ID} \leq -0.2$ V	L	L
$-0.2$ V < $V_{ID} < -0.01$ V	L	?
$-0.01$ V $\leq V_{ID}$	L	H
X	H	Z
Open Circuit	L	H
Short Circuit	L	H
IDLE Bus	L	H
X	Open	Z

(1) H = high level; L = low level; Z = high impedance; X = irrelevant;  
? = indeterminate

### Receiver Failsafe

The differential receiver is “failsafe” to invalid bus states caused by:

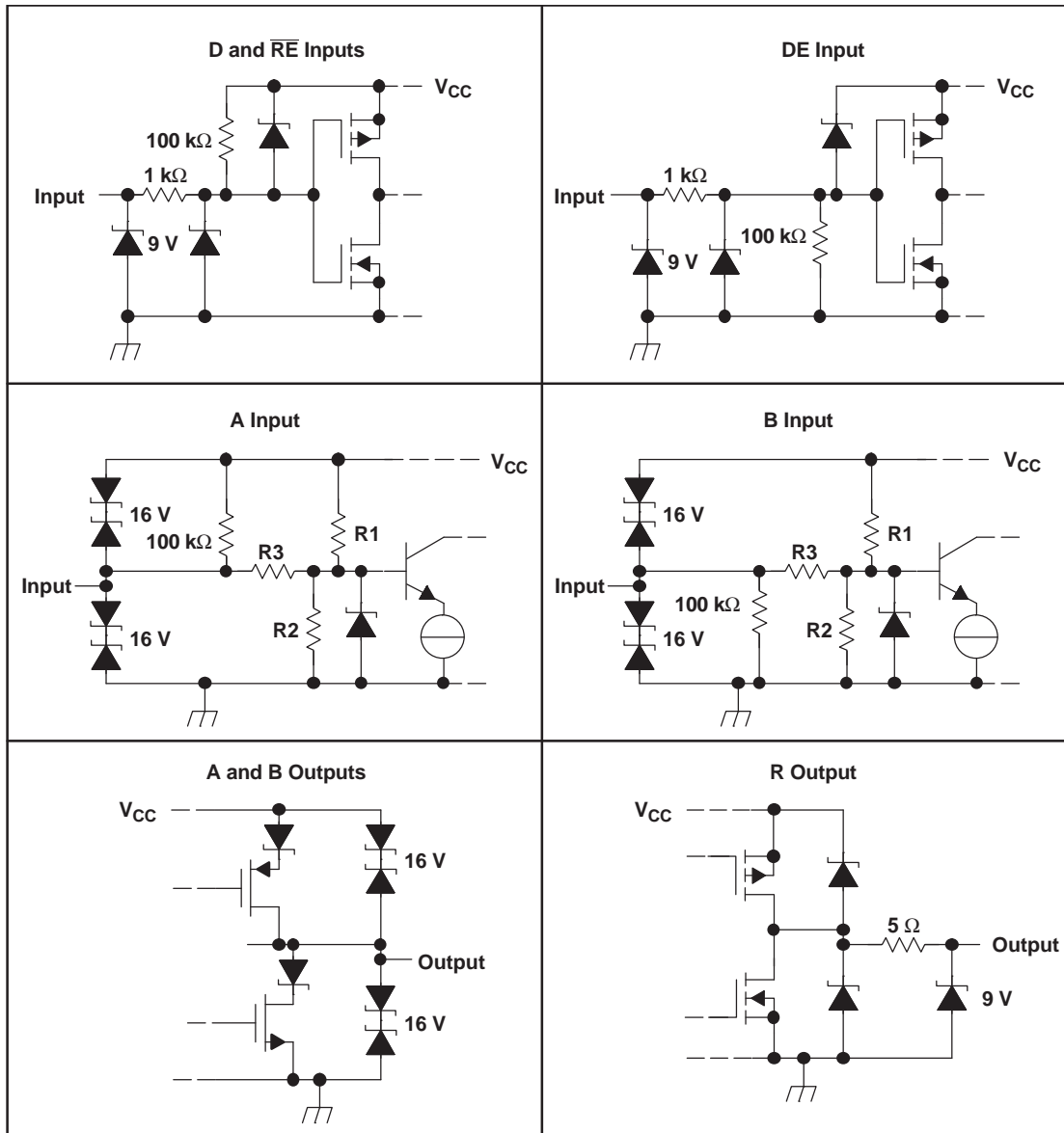
- open bus conditions such as a disconnected connector,
- shorted bus conditions such as cable damage shorting the twisted-pair together, or
- idle bus conditions that occur when no driver on the bus is actively driving

In any of these cases, the differential receiver outputs a failsafe logic High state, so that the output of the receiver is not indeterminate.

Receiver failsafe is accomplished by offsetting the receiver thresholds so that the “input indeterminate” range does not include zero volts differential. To comply with the RS-422 and RS-485 standards, the receiver output *must* output a High when the differential input  $V_{ID}$  is more positive than +200 mV, and *must* output a Low when the  $V_{ID}$  is more negative than -200 mV. The receiver parameters which determine the failsafe performance are  $V_{IT+}$  and  $V_{IT-}$  and  $V_{HYS}$ . As seen in the [Receiver Electrical Characteristics](#) table, differential signals more negative than -200 mV will always cause a Low receiver output. Similarly, differential signals more positive than +200 mV will *always* cause a High receiver output.

When the differential input signal is close to zero, it will still be above the  $V_{IT+}$  threshold, and the receiver output is High. Only when the differential input is more negative than  $V_{IT-}$  will the receiver output transition to a Low state. So, the noise immunity of the receiver inputs during a bus fault condition includes the receiver hysteresis value  $V_{HYS}$  (the separation between  $V_{IT+}$  and  $V_{IT-}$ .) as well as the value of  $V_{IT+}$ .

EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



	R1/R2	R3
SN65HVD05	9 kΩ	45 kΩ
SN65HVD06	36 kΩ	180 kΩ
SN65HVD07	36 kΩ	180 kΩ

TYPICAL CHARACTERISTICS

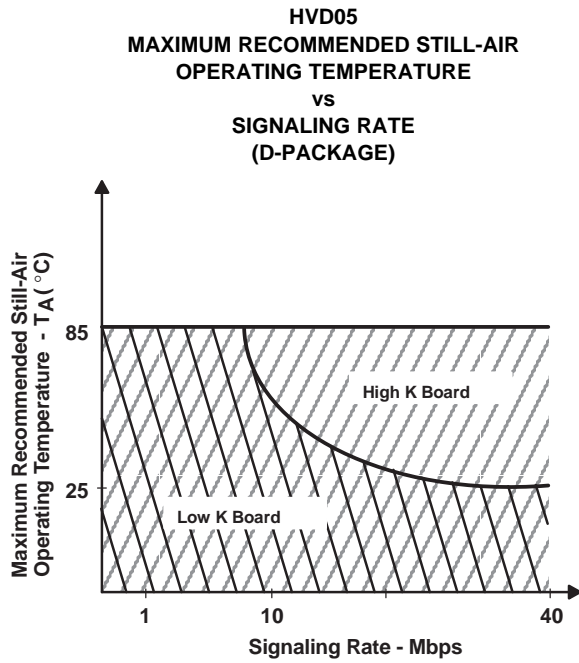


Figure 12.

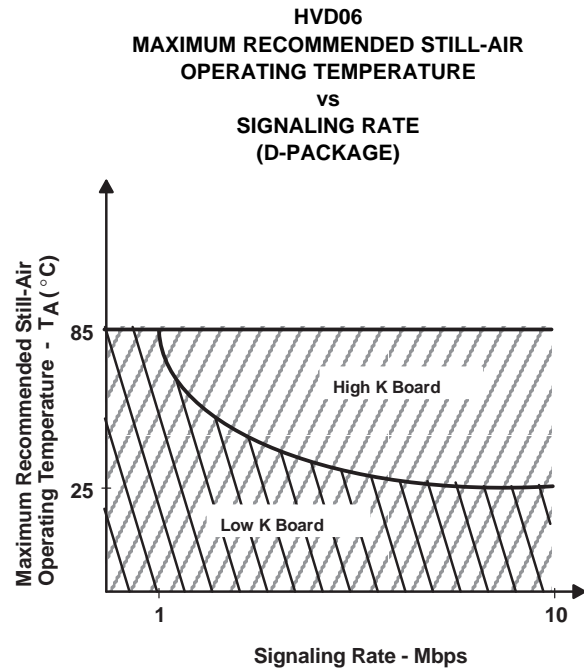


Figure 13.

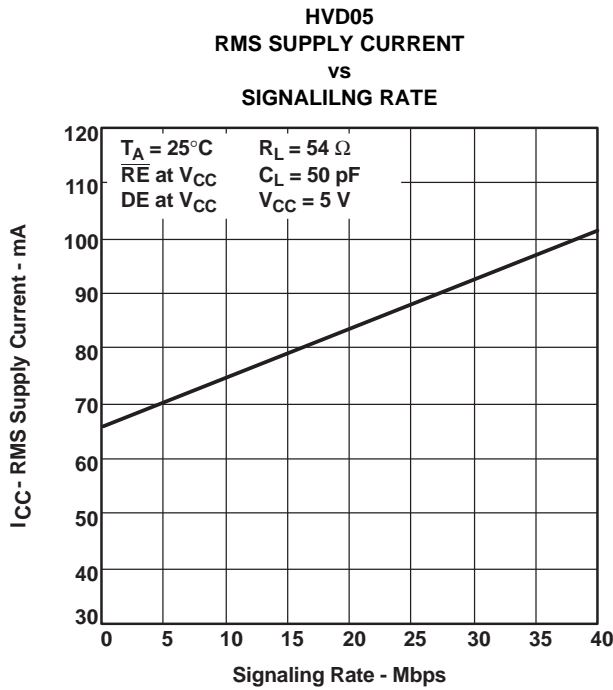


Figure 14.

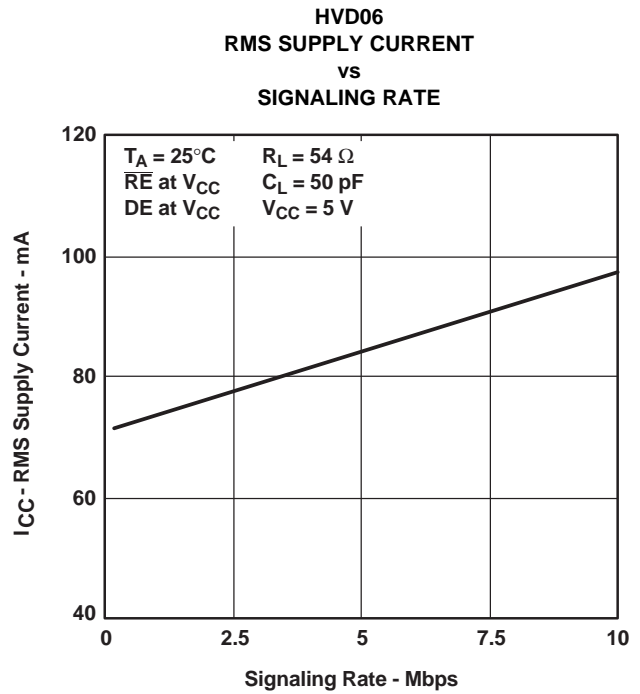


Figure 15.

TYPICAL CHARACTERISTICS (continued)

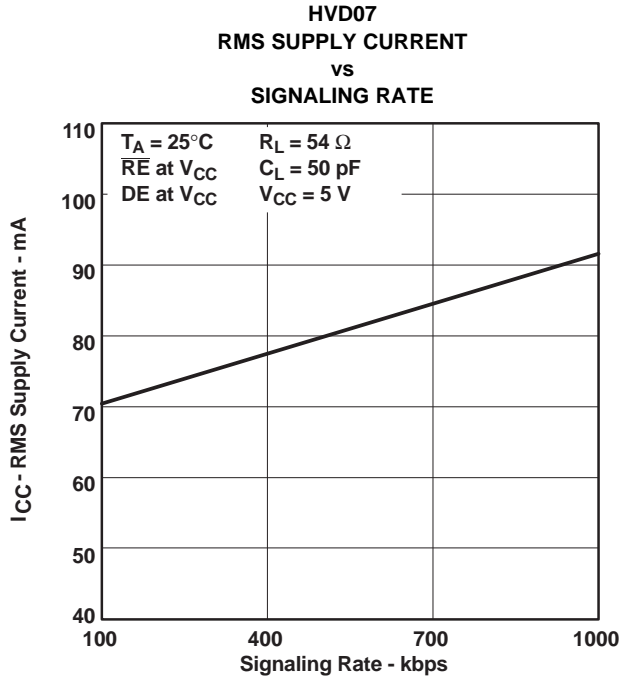


Figure 16.

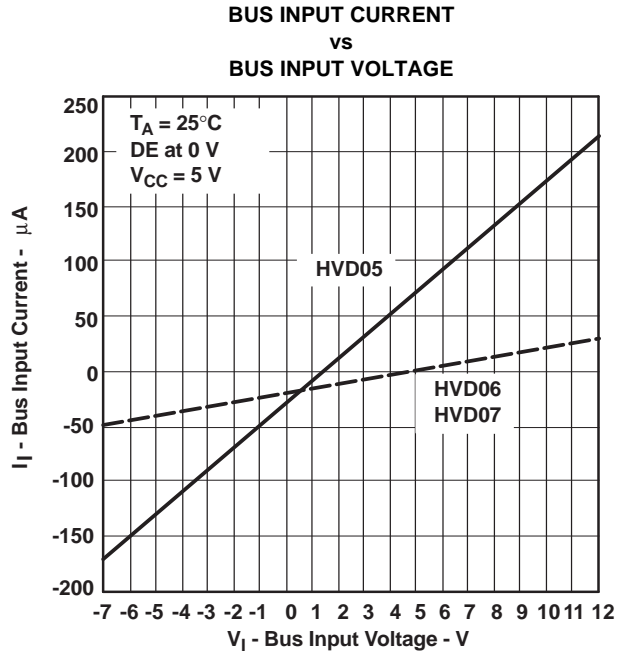


Figure 17.

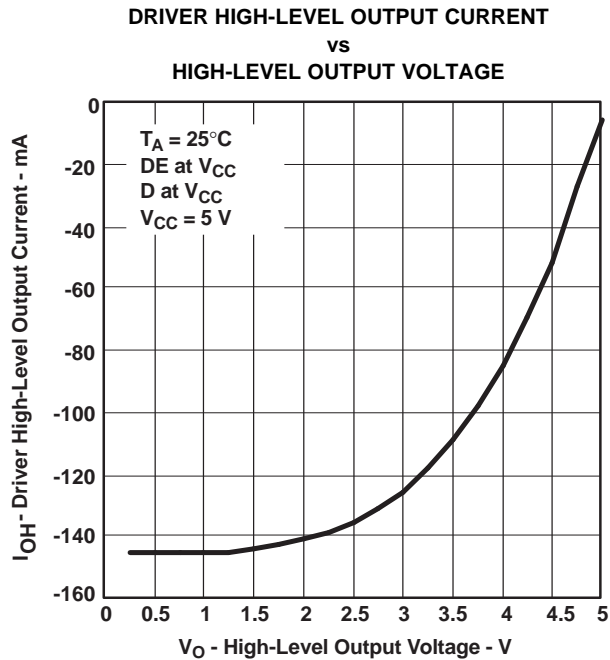


Figure 18.

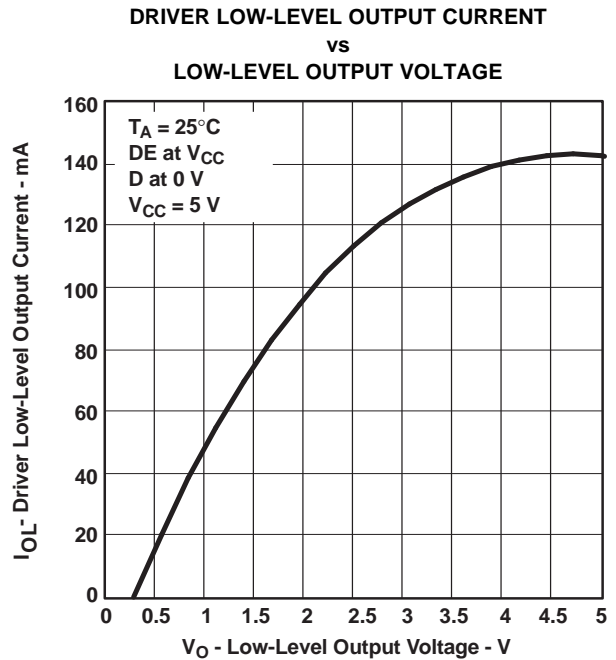
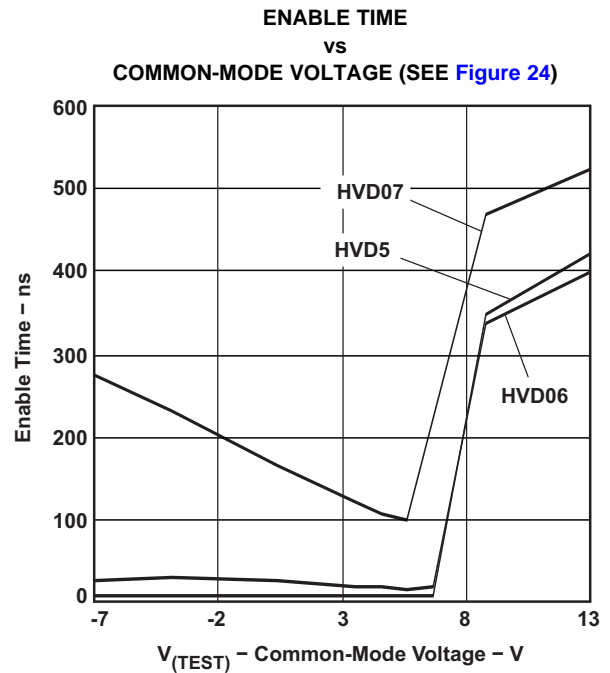
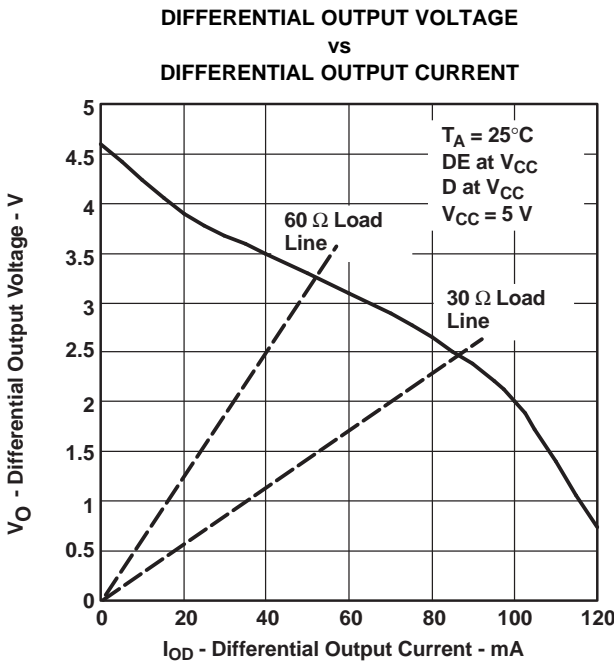
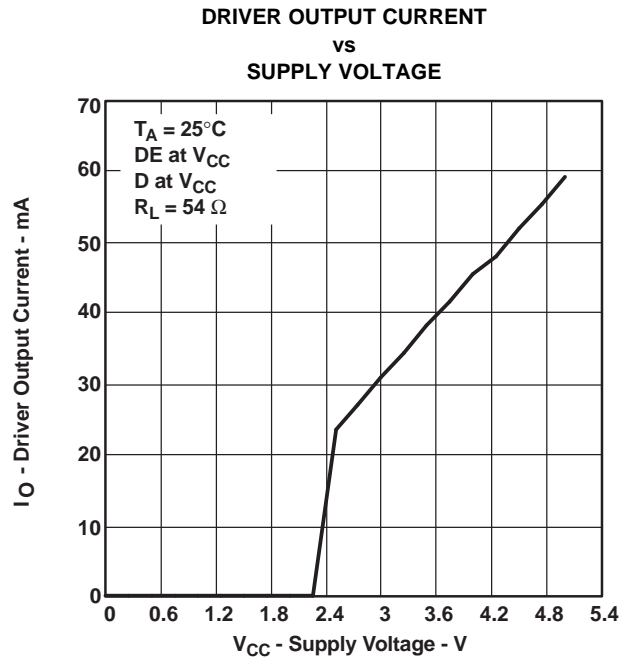
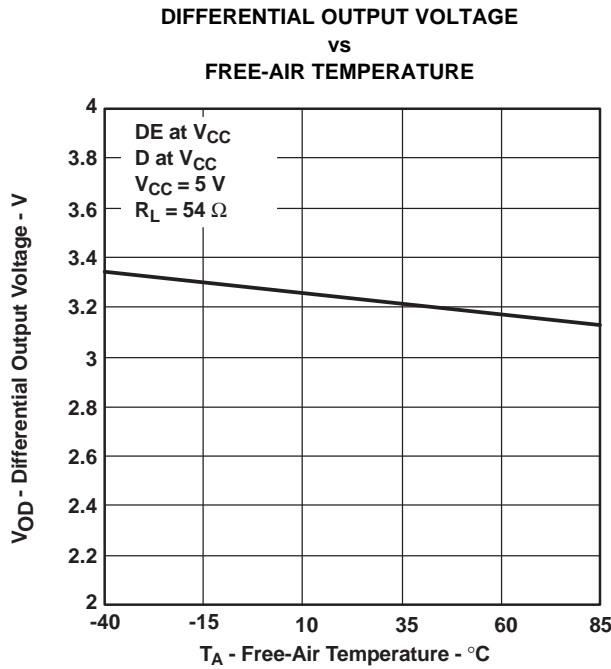


Figure 19.

TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

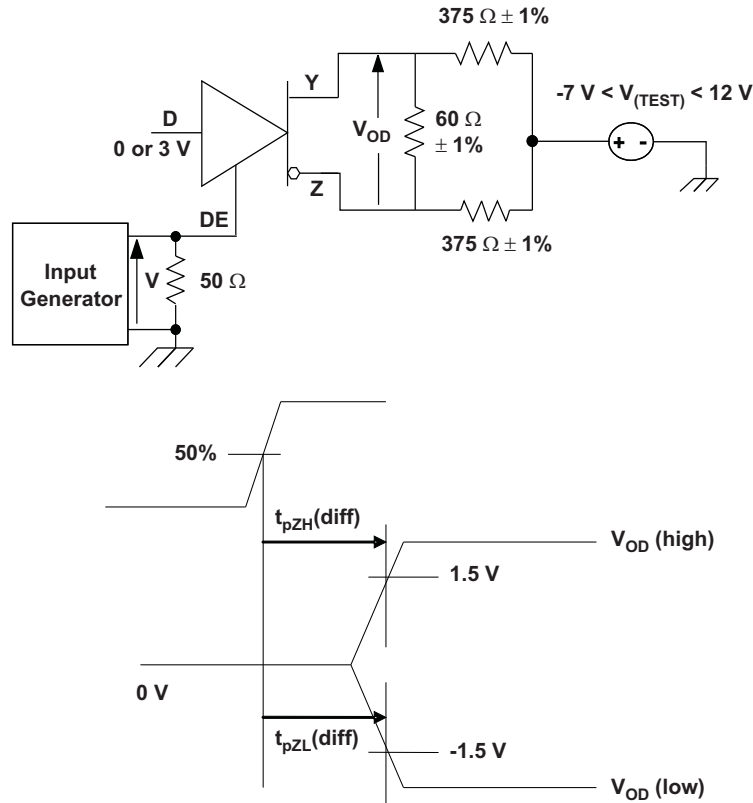
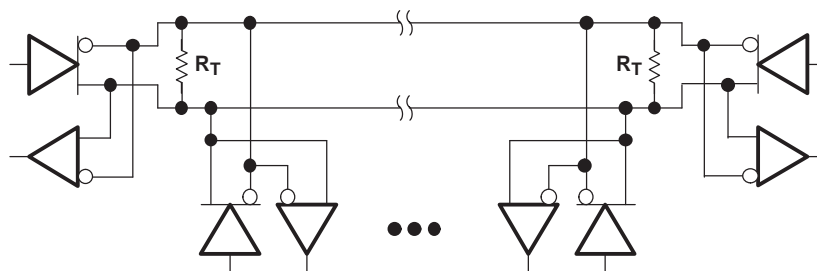


Figure 24. Driver Enable Time From DE to  $V_{OD}$

The time  $t_{pZL}(x)$  is the measure from DE to  $V_{OD}(x)$ .  $V_{OD}$  is valid when it is greater than 1.5 V.

**APPLICATION INFORMATION**



Device	Number of Devices on Bus
HVD05	64
HVD06	256
HVD07	256

NOTE: The line should be terminated at both ends with its characteristic impedance ( $R_T = Z_0$ ).  
Stub lengths off the main line should be kept as short as possible.

**Figure 25. Typical Application Circuit**

**REVISION HISTORY**

Changes from Revision D (July 2006) to Revision E	Page
• Added IDLE Bus to the Receivers Function Table .....	11
• Added the Receiver Failsafe paragraph. ....	11

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN65HVD05D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP05	<a href="#">Samples</a>
SN65HVD05DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP05	<a href="#">Samples</a>
SN65HVD05P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	65HVD05	<a href="#">Samples</a>
SN65HVD06D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP06	<a href="#">Samples</a>
SN65HVD06DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP06	<a href="#">Samples</a>
SN65HVD06DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP06	<a href="#">Samples</a>
SN65HVD06P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	65HVD06	<a href="#">Samples</a>
SN65HVD07D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP07	<a href="#">Samples</a>
SN65HVD07DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP07	<a href="#">Samples</a>
SN65HVD07DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP07	<a href="#">Samples</a>
SN65HVD07P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	65HVD07	<a href="#">Samples</a>
SN75HVD05D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	VN05	<a href="#">Samples</a>
SN75HVD05P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	75HVD05	<a href="#">Samples</a>
SN75HVD06D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	VN06	<a href="#">Samples</a>
SN75HVD06DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	VN06	<a href="#">Samples</a>
SN75HVD06P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	75HVD06	<a href="#">Samples</a>
SN75HVD07D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	VN07	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN75HVD07DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	VN07	<a href="#">Samples</a>
SN75HVD07DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	VN07	<a href="#">Samples</a>
SN75HVD07P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	75HVD07	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65HVD05DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN65HVD06DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN65HVD07DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75HVD06DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75HVD07DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN65HVD05DR	SOIC	D	8	2500	340.5	338.1	20.6
SN65HVD06DR	SOIC	D	8	2500	340.5	338.1	20.6
SN65HVD07DR	SOIC	D	8	2500	340.5	338.1	20.6
SN75HVD06DR	SOIC	D	8	2500	340.5	338.1	20.6
SN75HVD07DR	SOIC	D	8	2500	340.5	338.1	20.6



# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

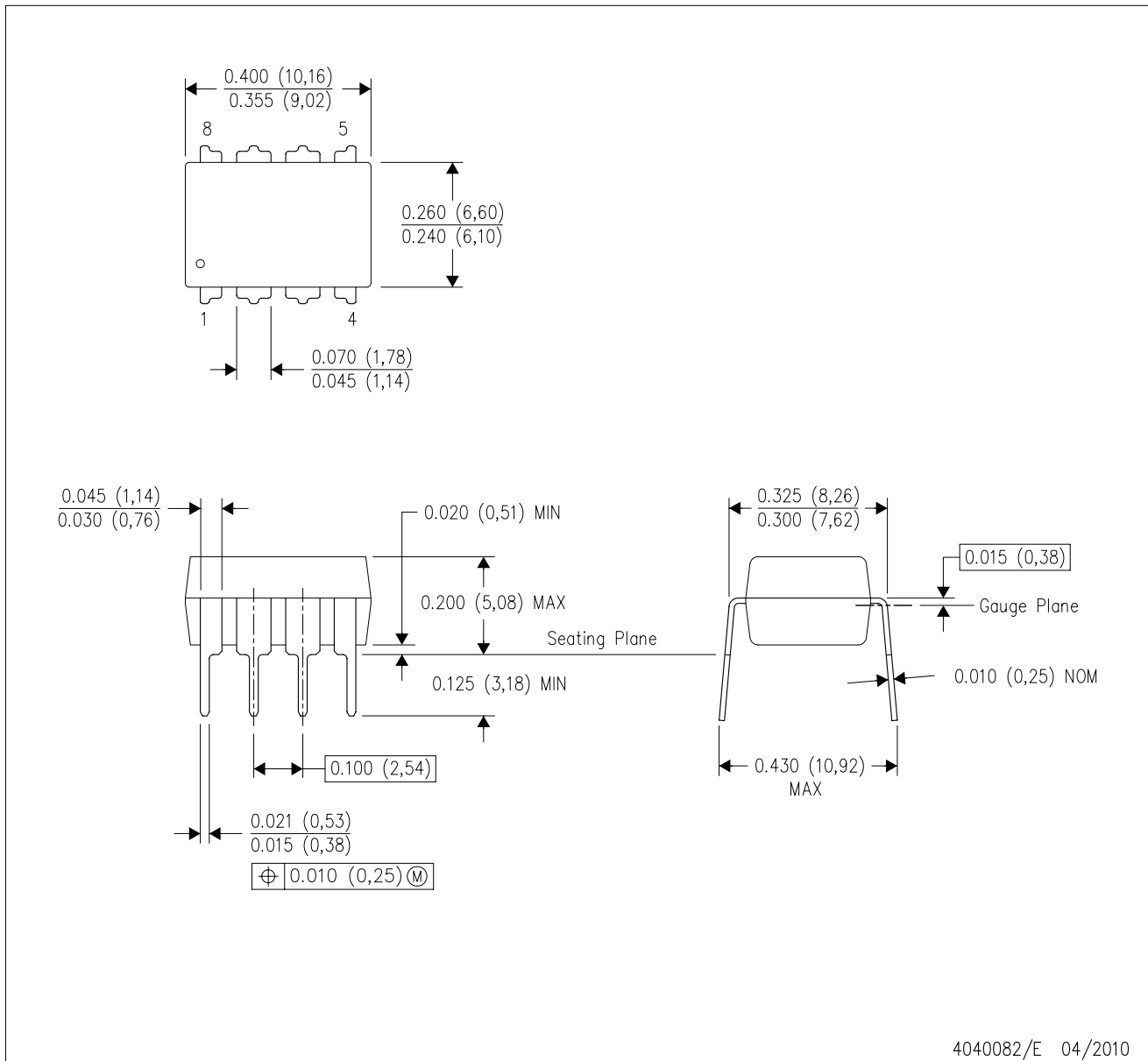
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



4040082/E 04/2010

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

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